

## Varistor

## **Material Data Sheet**

V di liotoi						•	natorial Bata	•••
Product Class:		House B722x	d varistor xT*					
Date		30.09.2	2019					
IMDS ID if available								
Version		5.06						
Product Part (IMDS: semi component)	Materia (IMDS: Ma		Material (Classification) VDA 231	Substance	TMPS**) [wt%]	CAS if applicable	typical mass of material [wt-%]	Traces see 1)
Active Part	ive Part Ceramic		3В	ZnO Bi2O3 Sb2O3 Co3O4 NiO others*)	91 4,0 2,5 1 0,5 1	1314-13-2 1304-76-3 1309-64-4 1308-06-1 1313-99-1	43,0	

Active Part	Ceramic	3B	Co3O4 NiO others*)		2,5 1 0,5 1	1308-06-1 1313-99-1	43,0	
Termination	Composite	4D	Cu or Ag		95 7440-50-8 7440-22-4		0,6	
			Glass frit (boro-silicat	ie)	5			
High melting point solder	Heavy Metal	1C8	Sn Ag Cu		96,5 3 0,5	7440-31-5 7440-22-4 7440-50-8	1,2	
Low melting point solder	Heavy Metal	1C8	Sn Bi		42 58	7440-31-5 7440-69-9	0,2	
		1C12	Cu		100	7440-50-8	6,0	
Leads	Heavy Metal 1C8 Sn			100	7440-31-5	0,2		
Spring	Heavy Metal	1C12	Cu Sn P		92,75 7,0 0,25	7440-50-8 7440-31-5 7723-14-0	3,2	
		1C8	Sn		100	7440-31-5	0,2	
Encapsulation	Duromer	2D Halogen-free coating	SiO2 Epoxy Pyromellitic dianhydride Phosphated epoxy others*)		46 40 6,5 5 2,5	60676-86-0 25036-25-3 89-32-7	7,9	
Plastic housing inner cover	Thermoplastic	2A	Aromatic Liquid Crystal Polymer (LCP) Glass fiber others*)		68 30 2	147310-94-9	12,8	
Plastic housing outer cover	Thermoplastic	2A	Poly butylene terephthalate (PBT) Glass fiber Brominated flame retardant 1 Brominated flame retardant 2 Sb2O3 Other*)		68 16,2 6 6 3 0,8	24968-12-5 65997-17-3 68928-70-1 71342-77-3 1309-64-4	24,7	
						Sum in total:	100	
sizes L x W [mm] 21,6 X 17	weight range [g] 3,8-5,5				weight range [g] 5,8-8.8 9,9-18,0	material numbe B72220T* B72220T	er part numbers T20K50-K420* T20K460-K1000*	
Not part of a Pro	oduct Class T20	)K50DF (B72220T050	0K105) and T20K510N	110K4 (B72220T0	511K109) is n	ot a part of this p	roduct class.	



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Date	30.09.2019
IMDS ID if available	
Version:	5.06

Contact	Mr. Christoph Ronner		Important remarks:					
Division	PPD Q QM		1)	The declaration limit is 0.1% as defined by IEC 62474 (IEC PAS 61906). Traces an				
Address	8530 Deutschlandsberg, AUSTRIA			product parts, substances etc. that are below a percentage of 0.1 % by weight, if otherwise regulated.				
	Tel: +43 3462 800 2139 mailto: functional.ppd-eqpm.db@tdk-electronics.tdk.com		2)	This Material Data Sheet contains typical values of the respective products set for				
*) others: .(not	t declarable or prohibit	ted substances acc. GADSL)		herein. We expressly point out that all values and statements contained herein are based on our best present knowledge and cannot be regarded as binding statements				
**) typical mass percentage of substance			or binding product specifications, unless otherwise explicitly agreed in writing. TDK ELECTRONICS AG AND ITS AFFILIATES HEREBY EXPRESSLY DISCLAIM ANY REPRESENTATION OR WARRANTY, WHETHER EXPRESS, IMPLIED OR STATUTORY, WITH REGARD TO THE STATEMENTS AND VALUES CONTAINED HEREIN, INCLUDING BUT NOT LIMITED TO ANY REPRESENTATION OR WARRANTY OF MERCHANTABILITY OR SUITABILITY FOR ANY PURPOSE.					
of Directive 201	1/65/EU of the European		the re	roducts are compatible with the requirements according to Art. 4 (substance restrictions) striction of the use of certain hazardous substances in electrical and electronic equipment. alid				
☑ no exemption:	,							
Exemption 6 (a)	a): Lead as an alloying element in steel for machining purposes and in galvanized steel containing up to 0,35 % lead by weight;							
Exemption 6 (b)	<li>Lead as an alloying element in aluminium containing up to 0,4 % lead by weight;</li>							
Exemption 6 (c)	Exemption 6 (c): Copper alloy containing up to 4 % lead by weight;							
Exemption 7 (a)	3 Exemption 7 (a): Lead in high melting temperature type solder (i.e. lead-based alloys containing 85 % by weight or more lead);							
Exemption 7 (c)	Exemption 7 (c)-1: Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound;							
Examplian 7 (a) III. Load in disloction corrections for a rotatively or 125 VAC or 250 V								

Exemption 7 (c)-II: Lead in dielectric ceramic in capacitors for a rated voltage of 125 V AC or 250 V DC or higher;

Exemption 7 (c)-III: Lead in dielectric ceramic in capacitors for a rated voltage of less than 125 V AC or 250 V DC;

Exemption 15: Lead in solders to complete a viable electrical connection between semiconductor die and carrier within integrated circuit Flip Chip packages;

Other Exemption than above ......